Technical Data Sheet

DOWSIL™ SC 4471 CV Thermally Conductive Compound

FEATURES & BENEFITS

- One part material – no need for ovens or curing
- Flowable
- Good thermal conductivity – removes heat from circuitry components
- Low oil bleed
- Controlled volatility

COMPOSITION

- Siloxane polymer matrix
- Thermally conductive fillers

White, non-curing, flowable thermally conductive compound with controlled volatility

APPLICATIONS

- DOWSIL™ SC 4471 CV Thermally Conductive Compound is designed to provide efficient thermal transfer for the cooling of PCB system assembly modules, including automotive control units and inverter units

TYPICAL PROPERTIES

Specification Writers: These values are not intended for use in preparing specifications.

Property	Unit	Result
One part or Two part		One
Color		White
Viscosity	cP	116,000
	mPa-sec	116,000
	Pa-sec	116
Specific Gravity (cured)		2.76
Volatile Content (105°C 24 hrs)	Wt%	0.11
Oil separation (105°C 24 hrs)	Wt%	0.02
Thermal Conductivity	BTU/hr-ft-°F	1.16
	W/mK	2
Volume Resistivity	Ohm-cm	2E+15

DESCRIPTION

Dow thermally conductive compounds are grease like silicone materials, heavily filled with heat-conductive metal oxides. This combination promotes high thermal conductivity, low bleed and high-temperature stability. The compounds are designed to maintain a positive heat sink seal to improve heat transfer from the electrical or PCB system assembly device to the heat sink or chassis, thereby increasing the overall efficiency of the device. PCB system assemblies are continually designed to deliver higher performance. Especially in the area of consumer devices, there is also a continual trend towards smaller, more compact designs. In combination these factors typically mean that more heat is generated in the device. Thermal management of PCB system assemblies is a primary concern of design engineers. A cooler device allows for more efficient operation and better reliability over the life of the device. As such, thermally conductive compounds play an integral role here. Thermally conductive materials act as a thermal "bridge" to remove heat from a heat source (device) to the ambient via a heat transfer media (i.e. heat sink). These materials have properties such as low thermal resistance, high thermal conductivity, and can achieve thin Bond Line Thicknesses (BLTs) which can help to improve the transfer of heat away from the device.

HOW TO USE

Allow printed grease pad to dry open for 24 hours before assembly. Dry time allows the small amount of carrier fluid to evaporate.

SOLVENT EXPOSURE

In general, the product is resistant to minimal or intermittent solvent exposure, however best practice is to avoid solvent exposure altogether.

USABLE LIFE AND STORAGE

The product should be stored in its original packaging with the cover tightly attached to avoid any contamination. Store in accordance with any special instructions listed on the product label. The product should be used by the indicated Exp. Date found on the label.

HANDLING PRECAUTIONS

PRODUCT SAFETY INFORMATION REQUIRED FOR SAFE USE IS NOT INCLUDED IN THIS DOCUMENT. BEFORE HANDLING, READ PRODUCT AND SAFETY DATA SHEETS AND CONTAINER LABELS FOR SAFE USE, PHYSICAL AND HEALTH HAZARD INFORMATION. THE SAFETY DATA SHEET IS AVAILABLE ON THE DOW WEBSITE AT WWW.CONSUMER.DOW.COM, OR FROM YOUR DOW SALES APPLICATION ENGINEER, OR DISTRIBUTOR, OR BY CALLING DOW CUSTOMER SERVICE.

LIMITATIONS

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

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To support customers in their product safety needs, Dow has an extensive Product Stewardship organization and a team of product safety and regulatory compliance specialists available in each area.

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